EMRB63 Series



REGULATORY COMPLIANCE

Lead Free	EU RoHS	China RoHS	REACH
\bigotimes	2011/65 + 2015/863	®	SVHC
COMPLIANT	COMPLIANT	COMPLIANT	COMPLIANT

MEMS Clock Oscillators LVCMOS (CMOS) 3.3Vdc 4 Pad 1.2mm x 2.0mm Plastic Surface Mount (SMD)

Measured at Nominal Vdd

-55°C to +125°C

ELECTRICAL SPECIFICATIONS Nominal Frequency 32.768kHz Frequency Tolerance/Stability Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, and Output Load Change ±75ppm Maximum over -10°C to +70°C ±100ppm Maximum over -40°C to +85°C Measured at 25°C ±2°C, at Vdd=3.3Vdc, Post Reflow **Frequency Tolerance** ±20ppm Maximum Aging at 25°C ±1ppm Maximum First Year Supply Voltage 3.3Vdc ±10% Input Current No Load. Nominal Vdd 1.0μΑ Typical (at 25°C), 2.2μΑ Maximum at Frequency Tolerance/Stability of ±100ppm Maximum over -40°C to +85°C 1.0μΑ Typical (at 25°C), 1.9μΑ Maximum at Frequency Tolerance/Stability of ±75ppm Maximum over -10°C to +70°C Output Voltage Logic High (Voh) IOH = -10µA 90% of Vdd Minimum Output Voltage Logic Low (Vol) IOL = +10µA 10% of Vdd Maximum **Rise/Fall Time** Measured from 10% to 90% of waveform 100nSec Typical, 200nSec Maximum **Duty Cycle** Measured at 50% of waveform 50 ±2(%) 15pF Maximum Load Drive Capability Output Logic Type CMOS Period Jitter (RMS) Measured at 25°C 35nSec Typical **Power Supply Ramp** Measured at 0Vdc to 90% of Vdd 100mSec Maximum

180mSec Typical, 500mSec Maximum at Frequency Tolerance/Stability of ±100ppm Maximum over -40°C to +85°C 180mSec Typical, 450mSec Maximum at Frequency Tolerance/Stability of ±75ppm Maximum over -10°C to +70°C

Storage Temperature Range

Start Up Time



PART NUMBERING GUIDE



MECHANICAL DIMENSIONS

All Dimensions in Millimeters

OUTPUT WAVEFORM & TIMING DIAGRAM

TEST CIRCUIT FOR CMOS OUTPUT

- **Note 1:** An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less Than 2mm) to the package ground and supply voltage pin is required.
- Note 2: A low input capacitance (<12pF), 10X attentuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) Passive probe is recommended.
- Note 3: Capacitance value CL includes sum of all probe and fixture capacitance. See applicable specification sheet for 'Load Drive Capability'.

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TAPE & REEL DIMENSIONS

Quantity per Reel: 3000 Units

All Dimensions in Millimeters

Compliant to EIA-481

RECOMMENDED SOLDER REFLOW METHOD

HIGH TEMPERATURE INFRARED/CONVECTION		
T_s MAX to T_L (Ramp-up Rate)	3°C/Second Maximum	
Preheat		
- Temperature Minimum (T _s MIN)	150°C	
- Temperature Typical (T _s TYP)	175°C	
- Temperature Maximum(T _s MAX)		
- Time (t _s)	60 - 180 Seconds	
Ramp-up Rate (T _L to T _P)	3°C/Second Maximum	
Time Maintained Above:		
- Temperature (T _L)	217°C	
- Time (t _L)	60 - 150 Seconds	
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum	
Target Peak Temperature(Tp Target)	250°C +0/-5°C	
Time within 5°C of actual peak (tp)	20 - 40 Seconds	
Ramp-down Rate	6°C/Second Maximum	
Time 25°C to Peak Temperature (t)	8 Minutes Maximum	
Moisture Sensitivity Level	Level 1	
Additional Notes	Temperatures shown are applied to body of device.	

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

RECOMMENDED SOLDER REFLOW METHOD

LOW TEMPERATURE INFRARED	
T_s MAX to T_L (Ramp-up Rate)	5°C/Second Maximum
Preheat - Temperature Minimum (T _s MIN)	N/A
 Temperature Typical (T_s TYP) Temperature Maximum(T_s MAX) Time (t_s) 	N/A 60 - 120 Seconds
Ramp-up Rate (T _L to T _P)	5°C/Second Maximum
Time Maintained Above:	450%C
- Temperature (T_L) - Time (t_L)	200 Seconds Maximum
Peak Temperature (T _P)	240°C Maximum
Target Peak Temperature (TP Target)	240°C Maximum 2 Times / 230°C Maximum 1 Time
Time within 5°C of actual peak (t _p)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
Ramp-down Rate	5°C/Second Maximum
Time 25°C to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to body of device.

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

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